



# Green Microfactories: Products from Waste

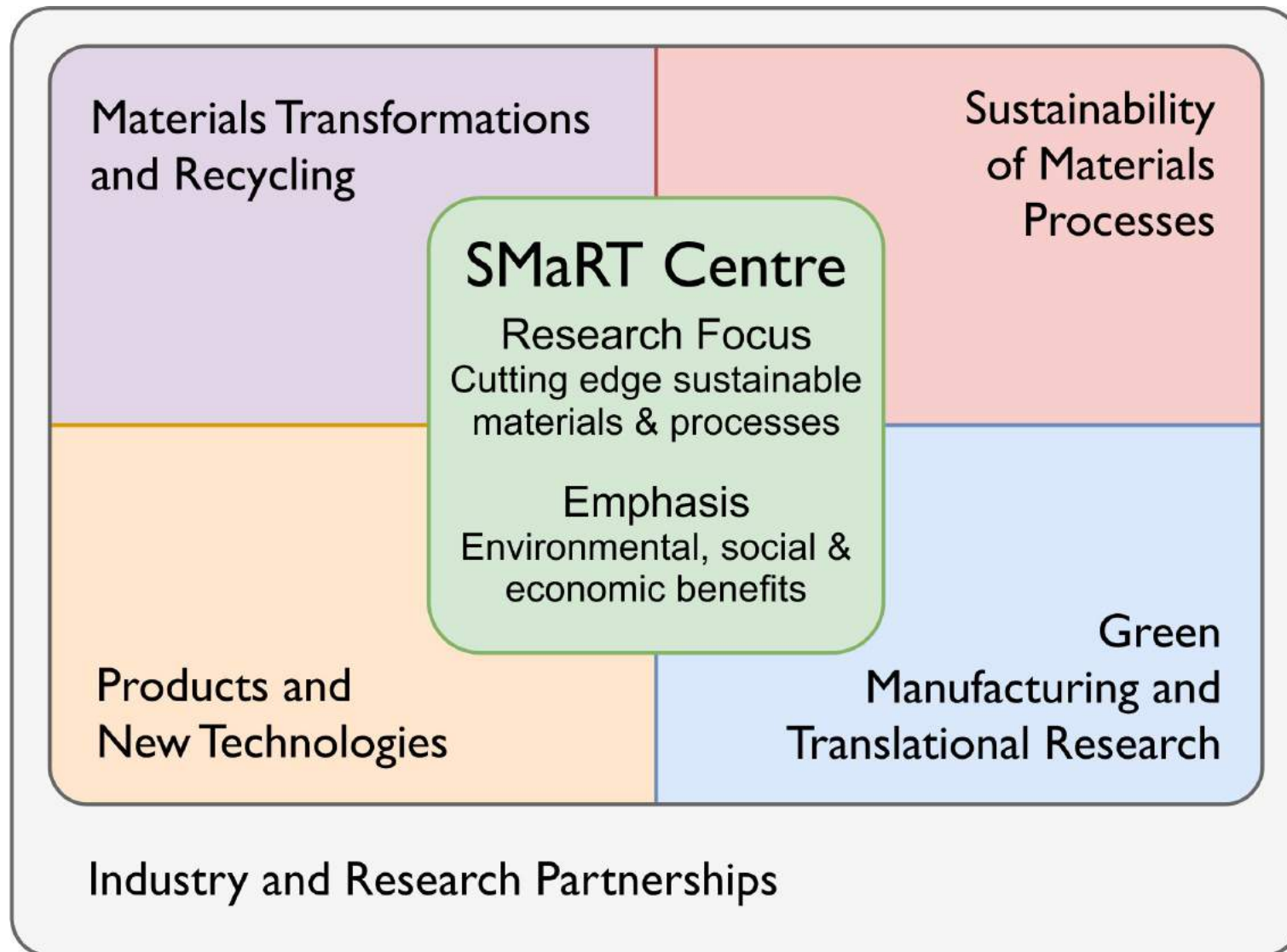
**Professor Veena Sahajwalla**

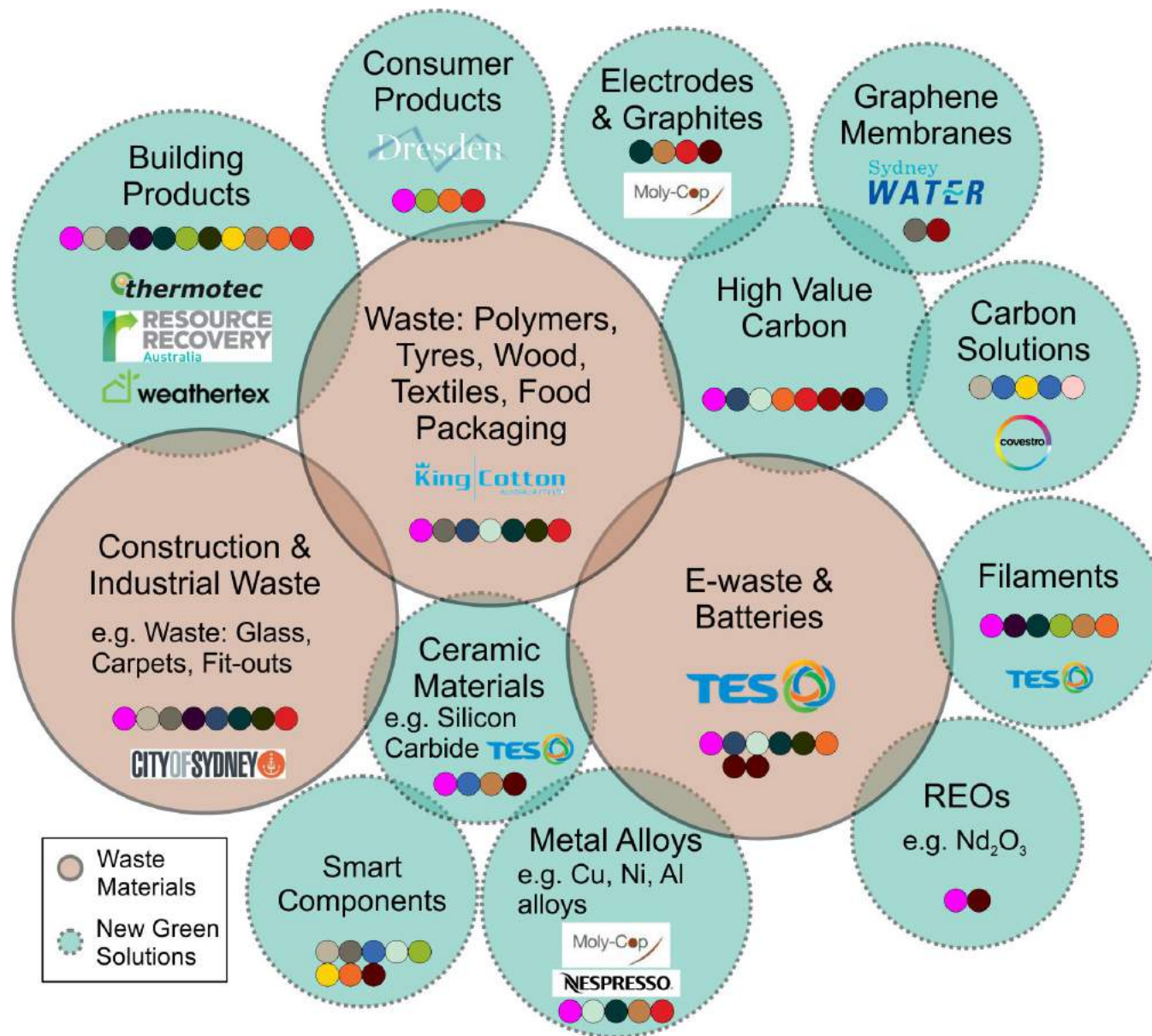
ARC Laureate Fellow

Director, ARC Research Hub:

*Transforming waste directly in cost-effective green manufacturing*







- The traditional 3 R's – Reduce, Reuse, Recycle – cannot cope with the complexity and volume of waste generated
- Need to reimagine and innovate in our approach to waste management
- Waste to value



# Electronic Waste (E-Waste)

- Electronic waste covers a wide range of end-of-life electric and electronic equipment considered obsolete by their users
- Increasing from 3% to 5% every year.
- 400-700 million computers will be generated in developing countries by 2030
- According to the EPA, electronic waste is growing 2-3 times faster than any other waste

Each year around 50 million tones of e-waste are produced



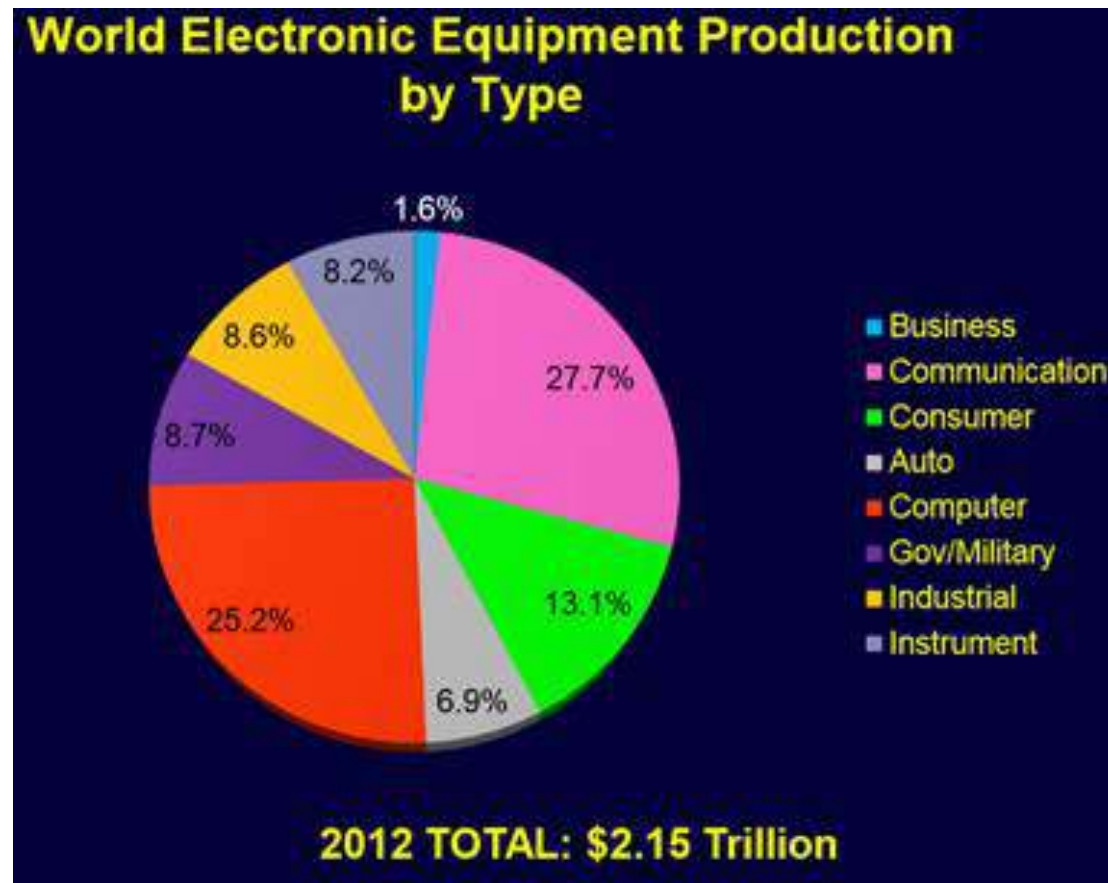
# E-waste





# Electronic Waste

In 2012 world electronic equipment production was \$2.15 trillion<sup>1</sup> and 25% of that is related to computer production and more than 27% is communication equipment.

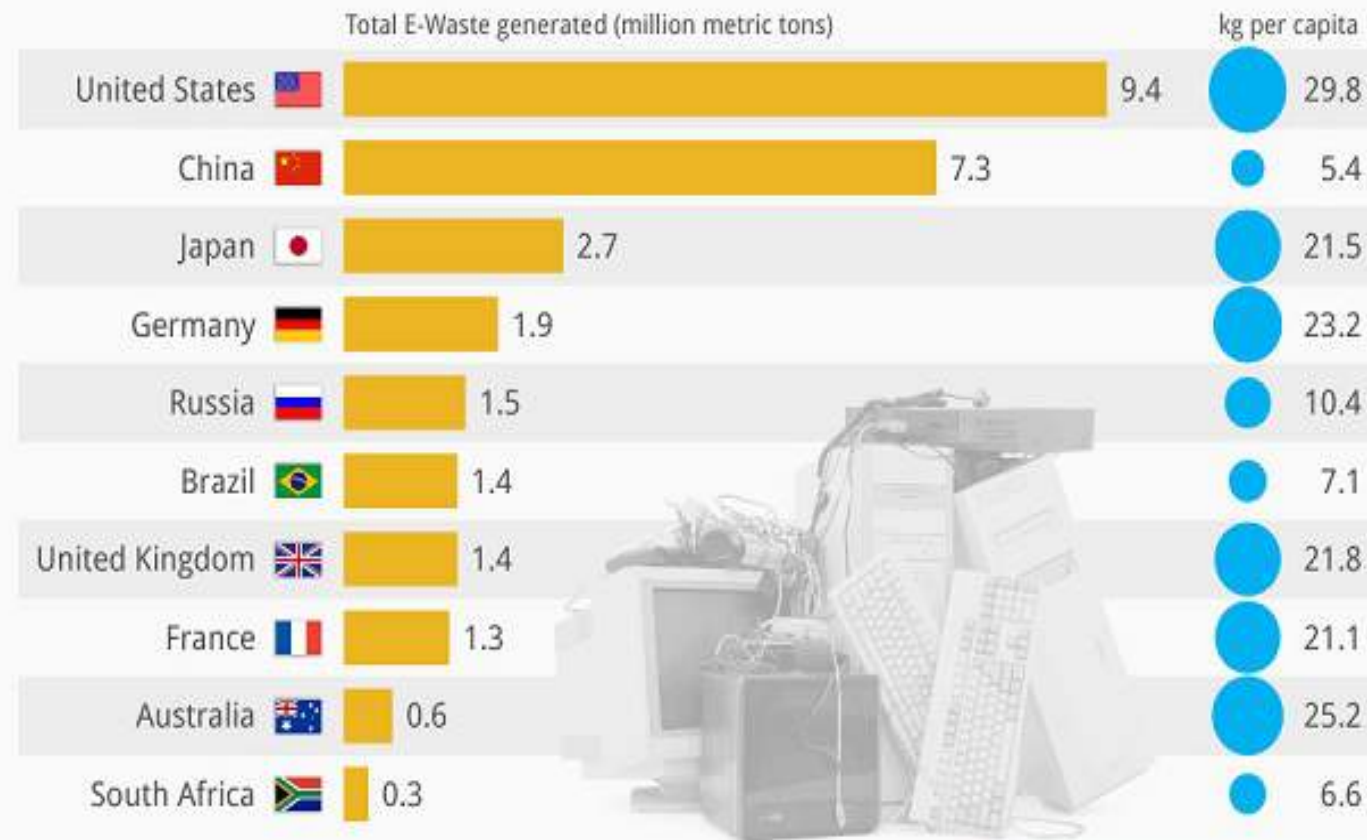


Ref: <https://www.ttieurope.com/docs/IO/29785/20130929.pdf>

# Growth of E-waste

## 49 Million Tons of E-Waste Were Generated in 2012

Amount of electronic waste generated in selected countries in 2012





# The E-waste Challenge & Opportunity

Worldwide, the UN Environment Program estimates **42 million tonnes** of electronic waste was generated in 2014, increasing from 3% to 5% every year.

This e-waste contained nearly **\$70 billion** worth of embedded resources.

In Australia, **4 million computers** are expected to be sold every year and **less than 1.5 %** will be recycled

PCBs typically contain 40 wt% metals, 30 wt% organics and 30 wt% ceramics



# Problems with Incineration / Field Burning

- Release of Dioxins and Furans to the atmosphere.
- Loss of pure metals due to oxidation process.
- Loss of valuable carbon during burning process



# Environmental concerns

The world production of ELVs was estimated at around 40 million units each year. Only in USA, over 12 million vehicles reach end of life each year.

Around 75-80% of shredded materials, mainly ferrous and non-ferrous fractions, are further processed and recycled, while the remaining light non-metals fraction, for which recycling processes are not in place yet, is disposed of.

Although there is insufficient data about the global production of ASR, in 2002, it has predicted at around 10 million tonnes.



# Composition of ASR



**Table 1**  
Composition of ASR.

Proximate analysis			Ultimate analysis				
Polypropylene	30–39%	C (%)	7.3–13.8	Br (%)	1.5–2.4	I (ppm)	52.9
Polyethylene	21–28%	Ti (%)	1.8–3.2	Cl (%)	0.19–0.23	K (ppm)	826
Polyurethane	9–14%	Ca (%)	0.8–1.1	N (%)	0.3–0.38	Mn (ppm)	18.4
Polycarbonate	7–12%	Si (%)	0.5–0.9	Ba (ppm)	102.7	Na (ppm)	325.1
Textiles	1–2%	Mg (%)	0.2–0.3	Cr (ppm)	35.0	Ni (ppm)	12.6
Moisture	0.8–1.1%	S (%)	0.3–0.4	Cu (ppm)	27.2	P (ppm)	583
Ash	2–3.9%	Al (%)	0.1–0.12	Fe (ppm)	88.7	Pb (ppm)	45.5
Others	4–8%	Sb (%)	1.5–2.3	Hg (ppm)	14.7	Sn (ppm)	361

Ref: ACS Sustainable Chemistry & Engineering, 5, 5440 – 5448.

doi: [10.1021/acssuschemeng.7b00774](https://doi.org/10.1021/acssuschemeng.7b00774)

“Green Hub” IH130200025



# E-waste Plastics

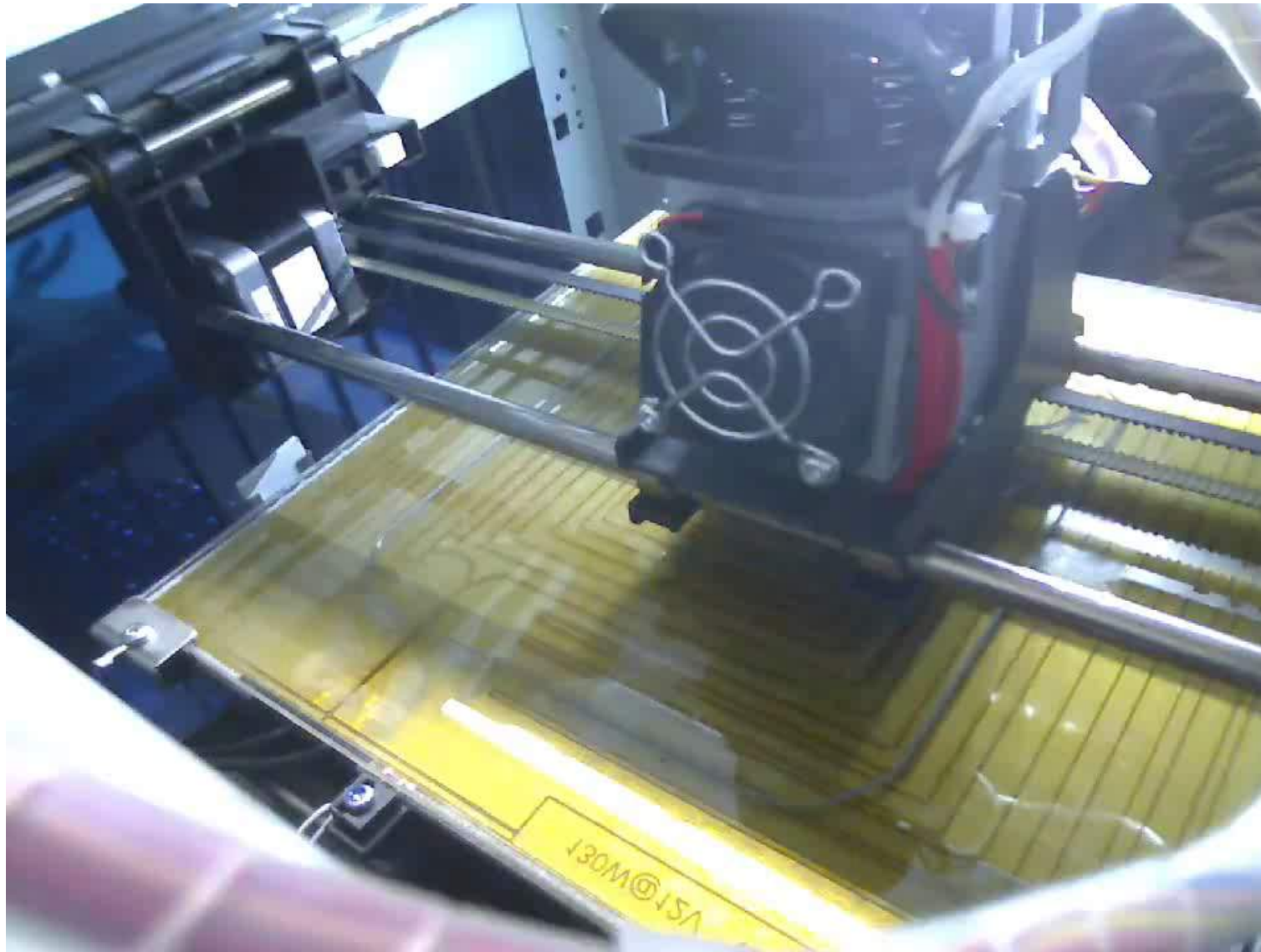
- Transform varied waste plastics into value added products
- Enable rapid characterisation and sorting of plastics
- The technology should be economically and environmentally sustainable
- It should readily integrate with industry
- The resultant value added products should be commercially relevant and have access to new and existing market



# Conversion of Waste Plastics into 3D Printed Products



# 3D Printing 100% Recycled Filament



# Percentage of Metals and Non-metals in PCBs

PCBs present a diverse and complex mixture of elements consisting:

- ~ 43% polymers
- ~ 34% refractories
- ~ 23% metals

*(Christian Hagelüken and Christopher W Corti., 2010)*

## Comparison of recovery of Copper from e-waste Vs ores

Copper in PCB range from 10% to 20%

*(Cui and Zhang, 2008; Schluep et al., 2009)*

Copper in ores range from ~0.5% to 1%

*(Davenport et al., 2002)*, requiring a different type of processing to recover metal.



# Printed Circuit Board

30% ceramics

30% polymers

40% metals

Cu 10-20%

Silver

Gold

Palladium

Carbon



Sources: Schluep, M, Hagelueken, C, Magalini, R, Maurer, C, Meskers, C, Mueller, E & Wang, F 2009, *Recycling - From E-Waste to Resources*.

Cui, J & Zhang, L 2008, 'Metallurgical recovery of metals from electronic waste: A review', *Journal of Hazardous Materials*, vol. 158, no. 2-3, pp. 228-56



### PCB 1

PC - Motherboard  
Ceramic Rich  
(Very Hard)

### PCB 2

PC-Motherboard  
Ceramic Rich  
(Hard)

### PCB 3

Printer Motherboard  
Polymer Rich  
(Soft)

### PCB 4

Old PC Motherboard  
Paper Rich  
(Soft)

### PCB 5

DVD Plyer  
Motherboard  
Polymer Rich  
(Very Hard)

Cu	✓	✓	✓	✓	✓
Sn	✓		✓	✓	✓
Pb			✓	✓	
Al	✓	✓		✓	✓
Si	✓	✓	✓	✓	✓
<b>Potential Alloys</b>	Al-Si Cu-Sn	Cu Al-Si	Cu-Sn Cu-Sn-Pb	Cu-Sn Cu-Sn-Pb	Cu-Sn Al-Si

# The SMaRT Vision

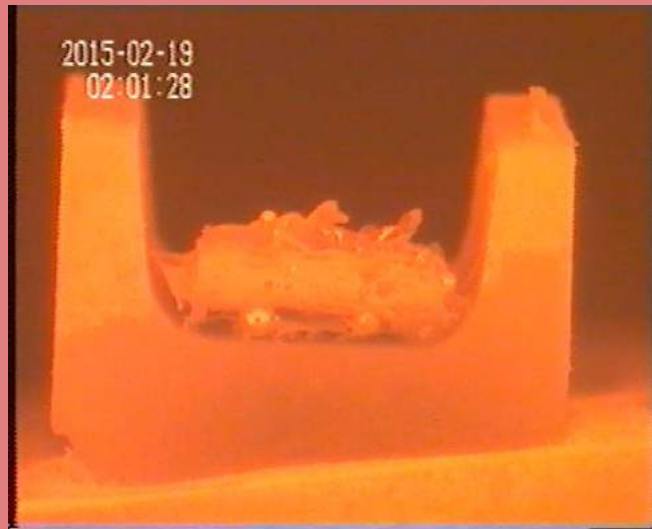
- Convert waste materials into high-value materials
- Minimise the energy-intensive transportation of waste
- Promote and support viable local economies and jobs
- An embodiment of distributed manufacturing

# Microfactory: A SMaRT Solution

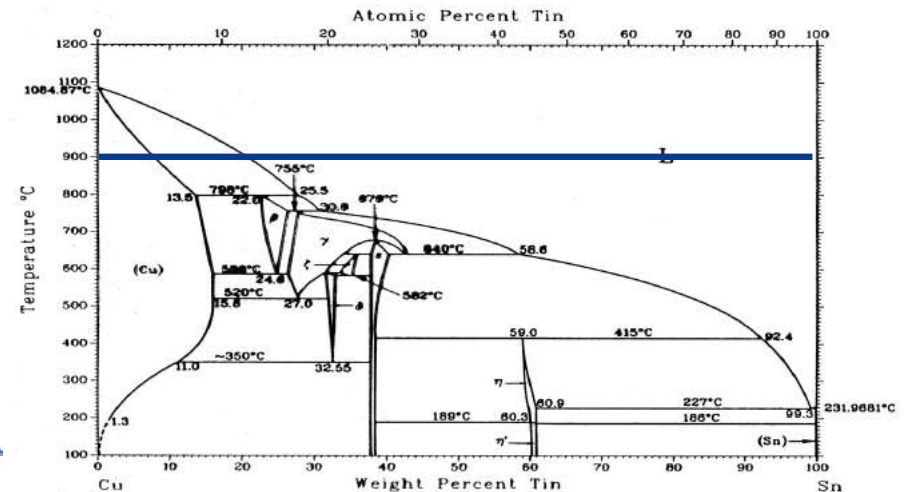
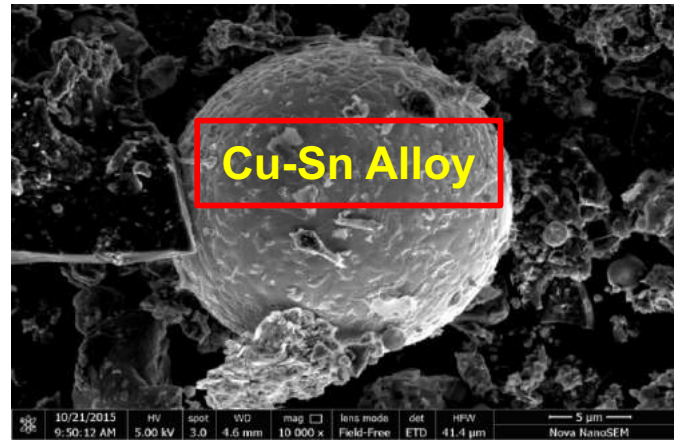
- Demonstrate the safe transformation of waste into high-value materials
- Market an Australian solution to a rapidly growing international problem
- Unlock the value embedded in waste
- Establish how microfactories could work in the global value chain



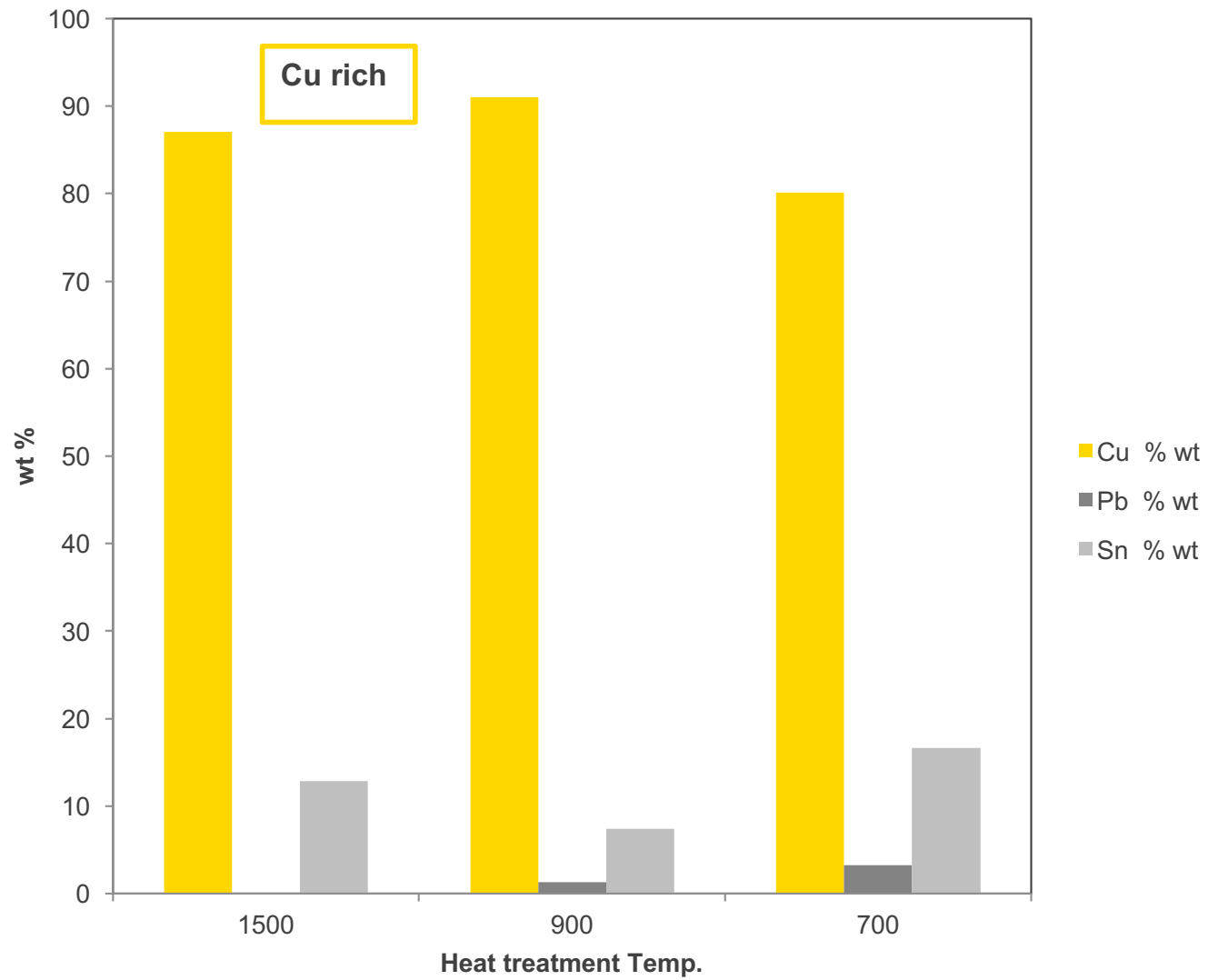
# Generation of Copper Rich Metallic Phases



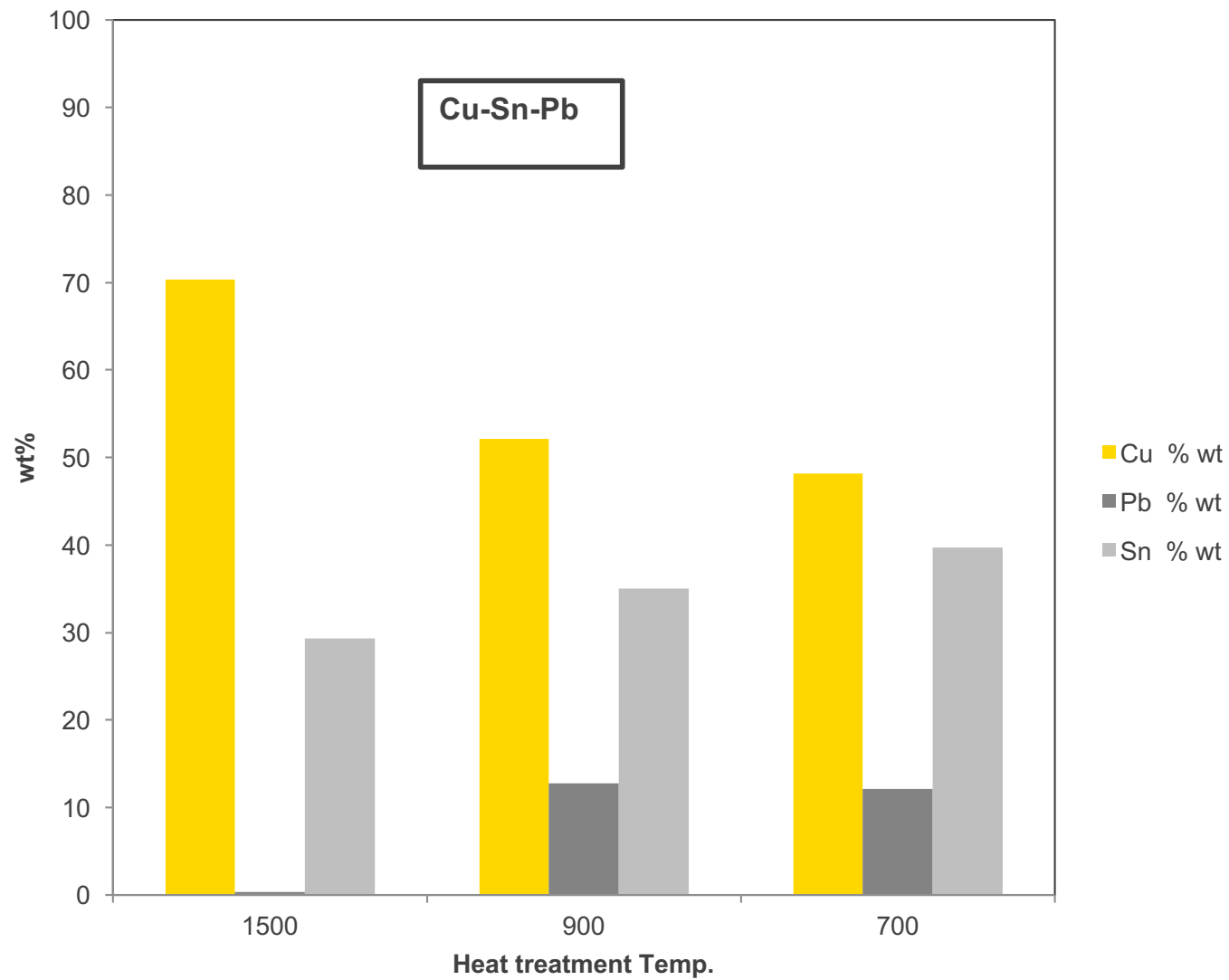
R. Cayumil, R. Khanna, M. Ikram-UI-Haq, R. Rajarao, A. Hill, and V. Sahajwalla, "Generation of copper rich metallic phases from waste printed circuit boards," *Waste Manag.*, vol. 34, no. 10, pp. 1783–1792, 2014.



# PCB 4 – Bulk Heat Treatment



# PCB 4 – Bulk Heat Treatment





# Products from Waste Glass

E-waste glass as a source of Silica

- Glass fraction of e-waste is a rich alternative source of silicon for production of  $\text{SiC}$  and  $\text{Si}_3\text{N}_4$
- Issues:
  - Low purity
  - Technically challenging
  - Economically unattractive
- Resources:
  - Computer monitors
  - Televisions
  - Devices with glass screens



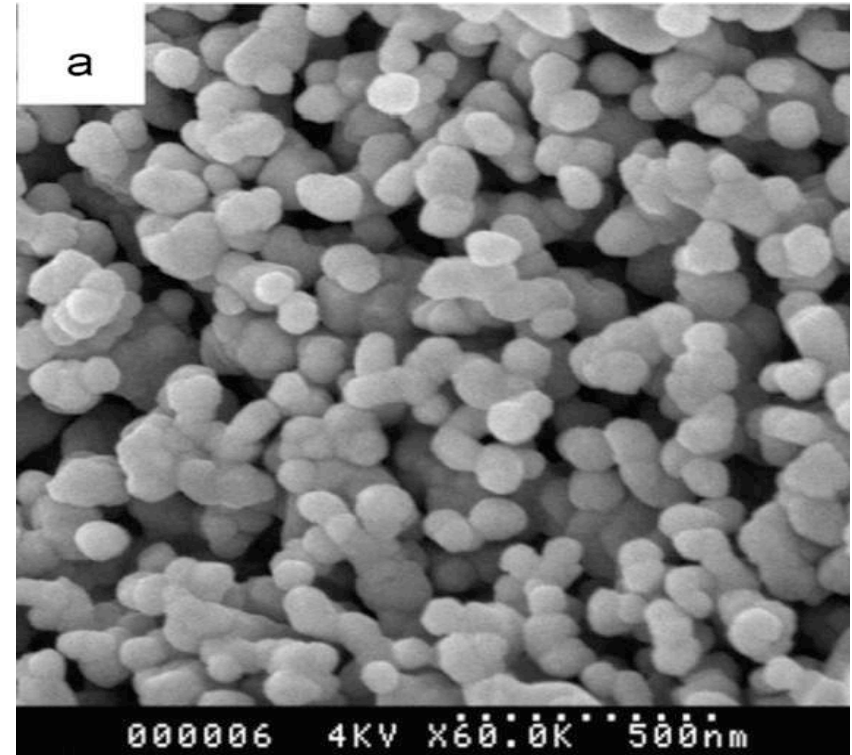
In Australia 88% of 4 million computers and 3 million TVs purchased annually ends up in landfills

oxides	$\text{Na}_2\text{O}$	$\text{SiO}_2$	$\text{Al}_2\text{O}_3$	$\text{CaO}$	$\text{MgO}$	$\text{MnO}$	$\text{Fe}_2\text{O}_3$
Weight percent	13.9	70.3	1.8	7.8	4.6	0.01	0.1

# Silicon Carbide Nanoparticles from Waste Compact Disks

## Applications

- As a high grade refractory material,
- Special material for polishing abrasive,
- Manufacture of rubber tyres
- High temperature spray nozzle manufacture
- Substrates for ICs
- Mirror coatings for high ultraviolet environments.



Rajarao, Ravindra & Ferreira, Rodolfo & Habib Fahandej Sadi, Seyed & Khanna, Rita & Sahajwalla, Veena. (2014). Synthesis of silicon carbide nanoparticles by using electronic waste as a carbon source. *Materials Letters*. 120. 65–68. 10.1016/j.matlet.2014.01.018.



# Thermal Isolation of Rare Earth Oxides

## Recycling of Nd-Fe-B Magnets

- Wide use of rare-earth elements
- Supply and cost challenges
  - Increasing domestic demand in China
  - Gradually tightened export quotas
- Inefficiencies in REEs ore mining process

## Applications:

- Computer and laptop hard drives
- Hybrid and electric vehicles
- Electric generators in turbines

Valuable Content:  
Neodymium, Dysprosium  
and praseodymium

Recycling:  
• less than 1% of REEs  
are recovered



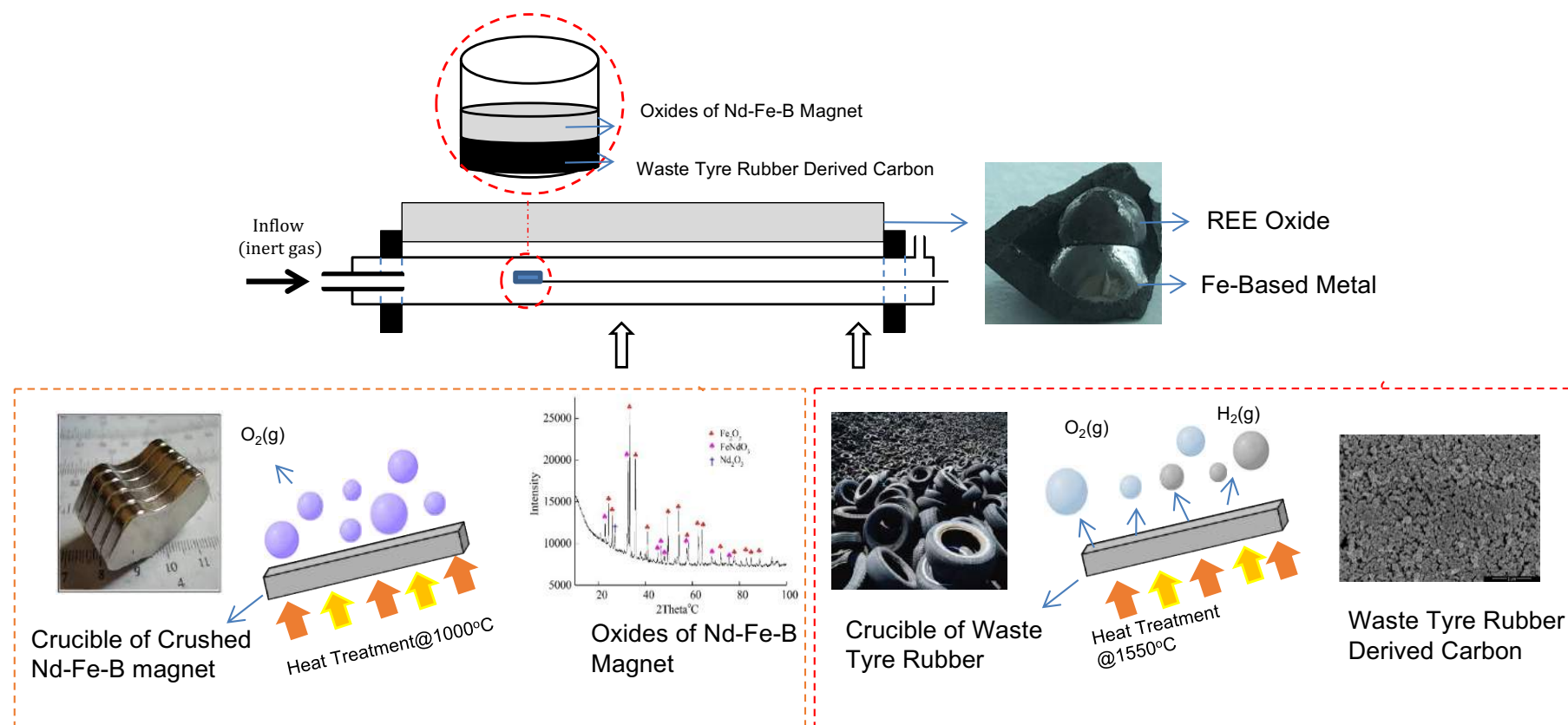


# Rare-earths from a hard drive (Separated from Iron Droplets)



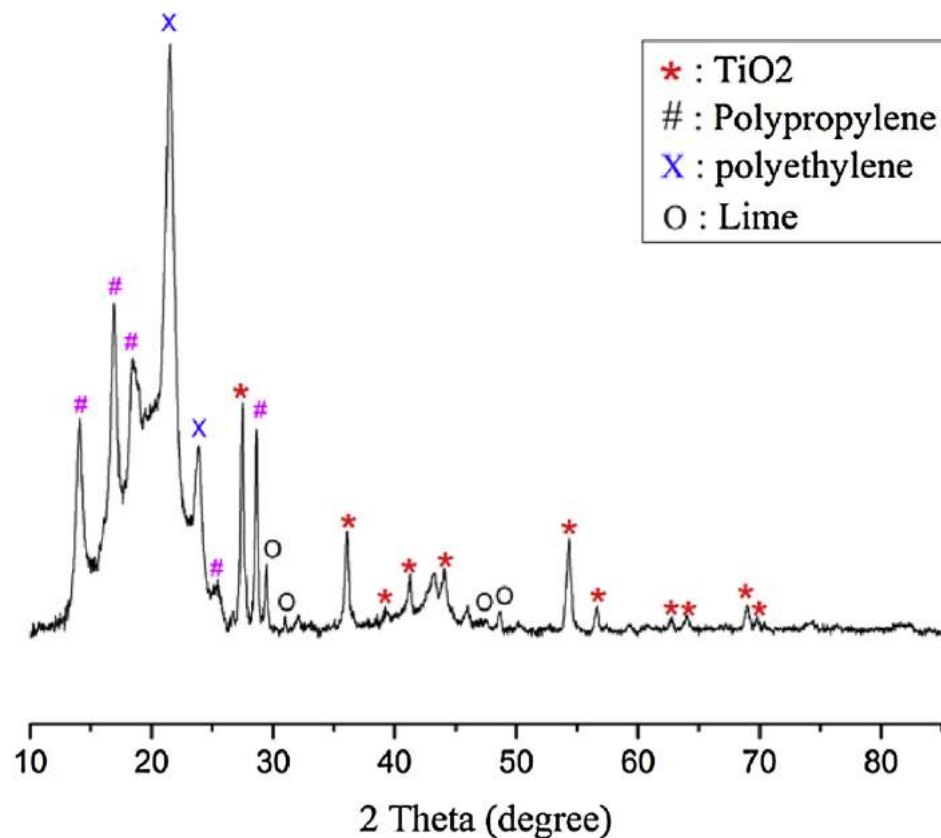


# Thermal Isolation of Rare Earth Oxides

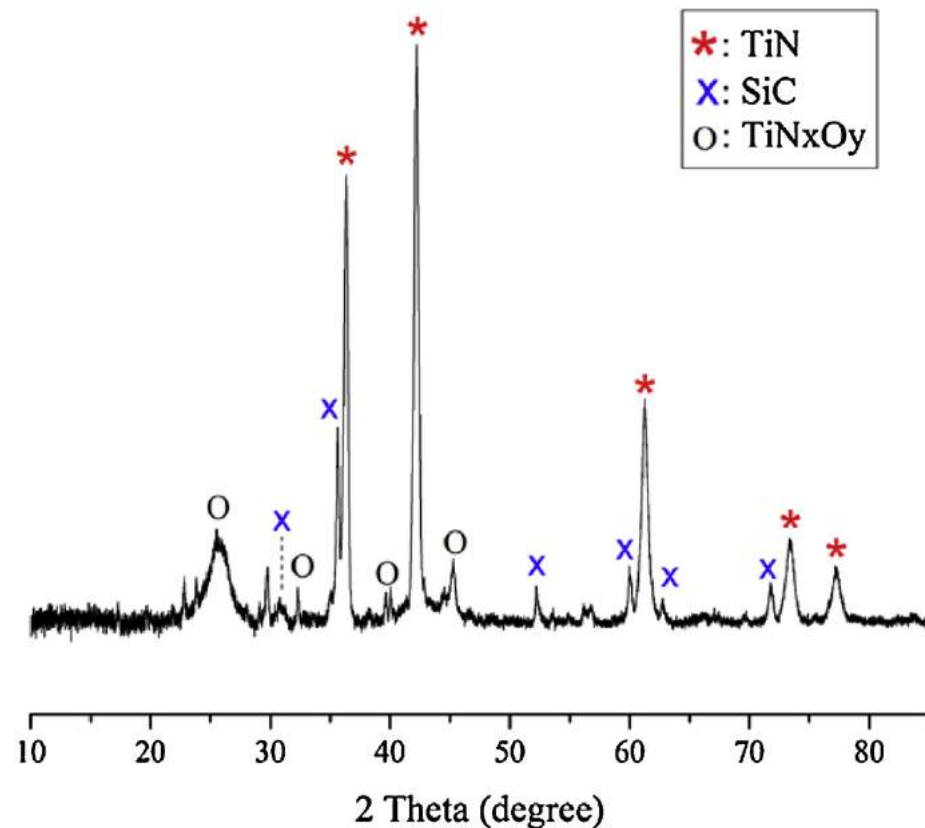


Maroufi, S.; Khayyam Nekouei, R.; Sahajwalla, V. Thermal Isolation of Rare Earth Oxides from Nd-Fe-B Magnets Using Carbon from Waste Tyres. *ACS Sustain. Chem. Eng.* 2017.

# XRD Pattern of ASR

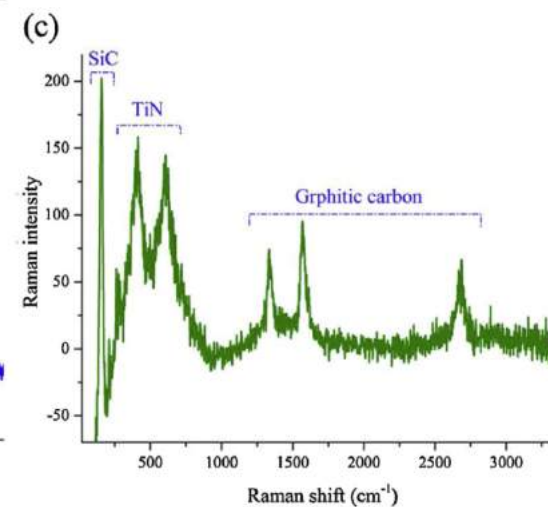
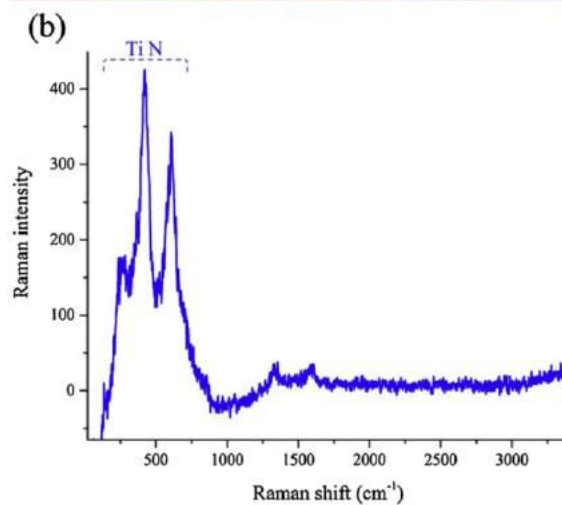
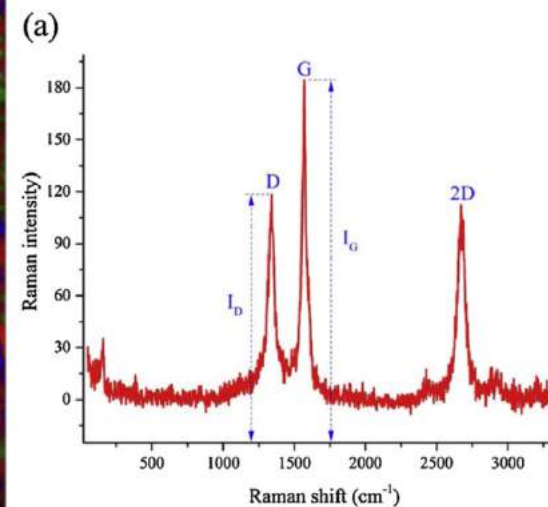
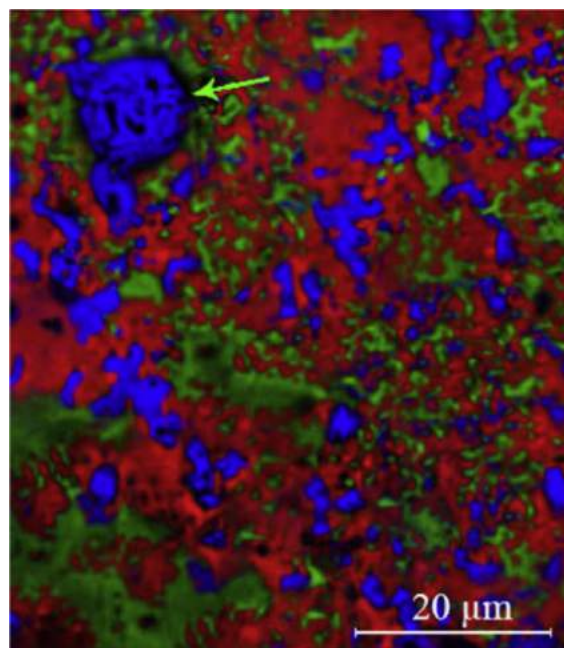


ASR



Selective Thermal Transformation

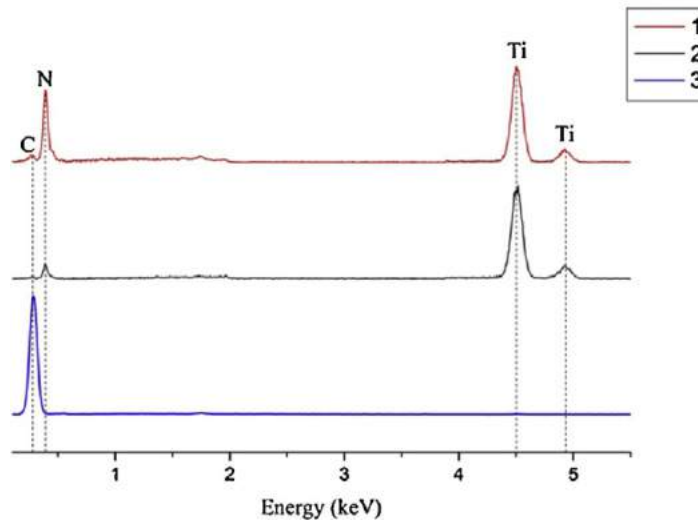
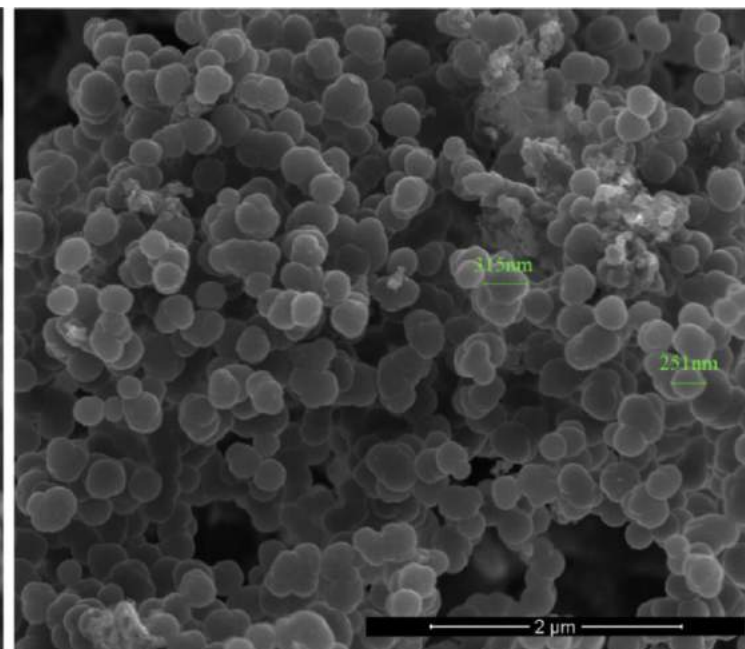
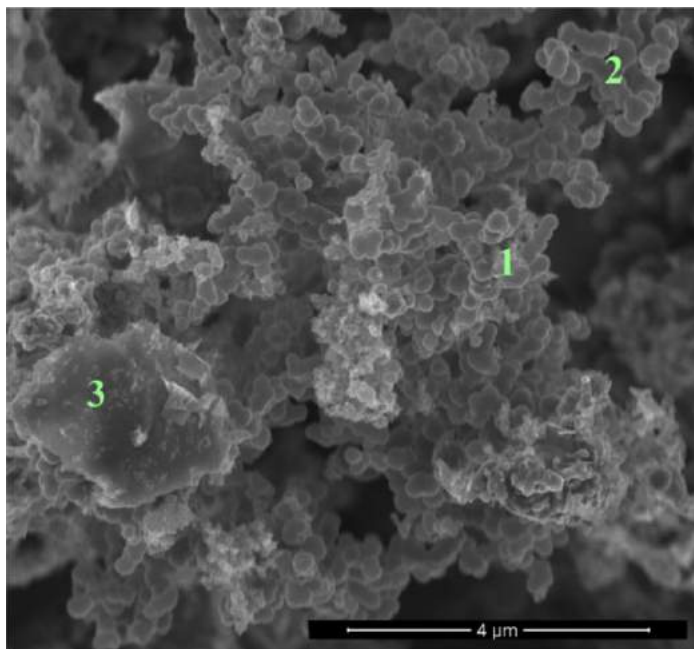
Ref: Journal of Analytical and Applied Pyrolysis, 2016, [doi:10.1016/j.jaap.2016.04.010](https://doi.org/10.1016/j.jaap.2016.04.010)  
 "Green Hub" IH130200025



RIM analysis of ASR-1550. (a) represents the Raman spectrum of the red region, (b) the blue region and (c) the green region. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)

Ref: Waste Management, 50, 173-183. doi:[10.1016/j.wasman.2016.02.003](https://doi.org/10.1016/j.wasman.2016.02.003)

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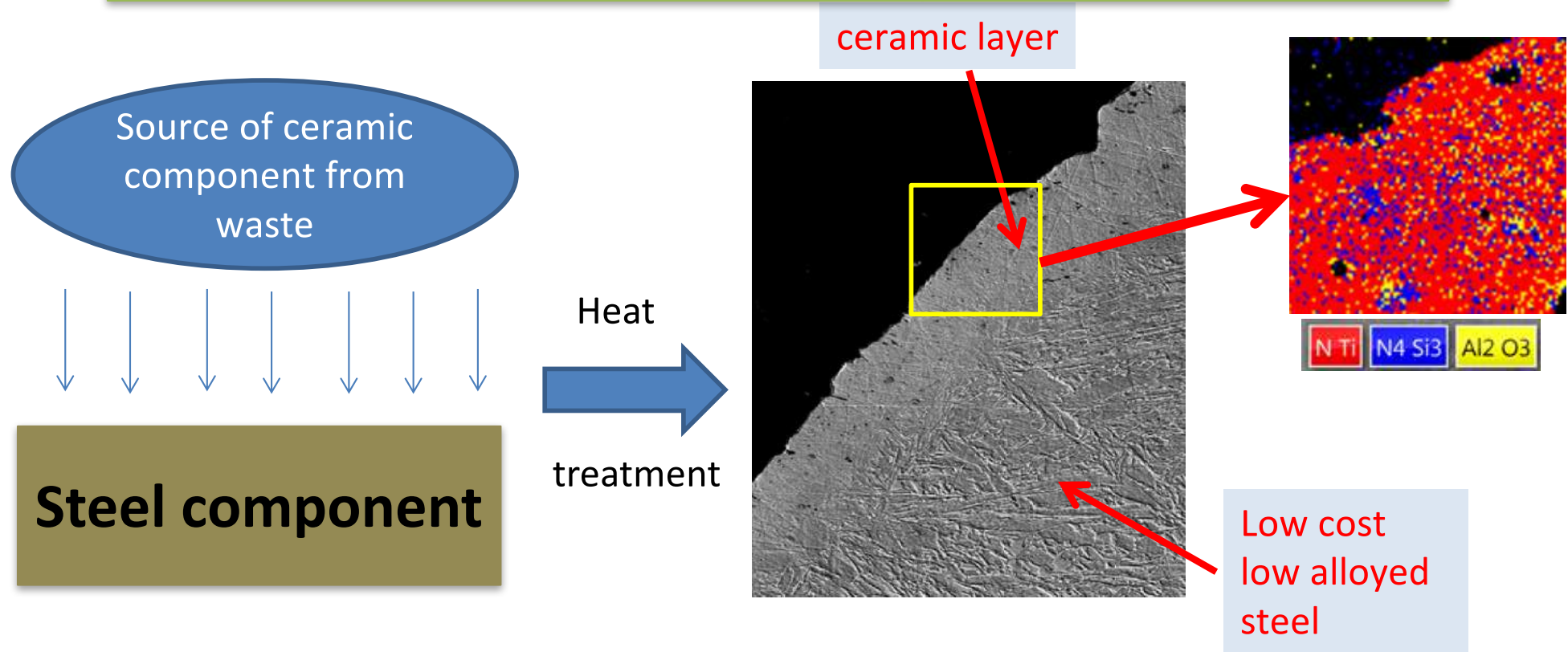


The morphology and elemental composition of the nanostructures in ASR-1550 at high magnification.

Ref: Materials Letters, 176, 17-20. doi:[10.1016/j.matlet.2016.04.066](https://doi.org/10.1016/j.matlet.2016.04.066)  
 "Green Hub" IH130200025



# Ceramic surface in steel to achieve superior properties using ASR

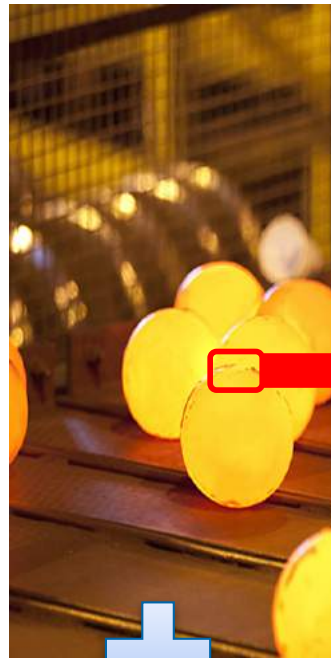


**This novel approach of producing innovative ceramic structure surface transformed the low cost low alloyed steel into super strength material for various industrial applications.**

Ref: Scientific Reports, 2016. **6**. 958  
"Green Hub" IH130200025

# Hybrid layering in steel to achieve superior properties

Original  
Grinding  
media



Grinding media  
with Hybrid  
Layering



**This novel approach of producing innovative multilayered structure transformed the low cost low alloyed steel into super strength material various for industrial applications.**

Ref: Scientific Reports, 2016. **6**. 958  
"Green Hub" IH130200025

# Microfactories: A Global Solution

- UNSW's microfactory technology promises to revolutionise recycling by producing cost-effective green materials.
- Relatively low entry costs for establishing recycling microfactories mean benefits can be decentralised, including the generation of jobs and economic returns in disadvantaged regions

# Acknowledgments

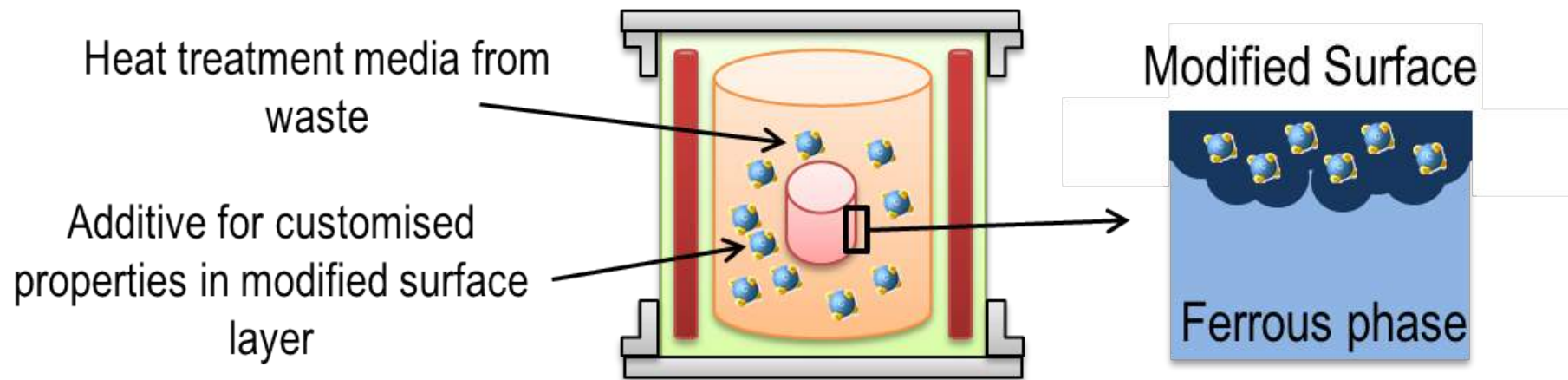
Australian Research Council through Laureate Fellowship

Grant no: FL140100215



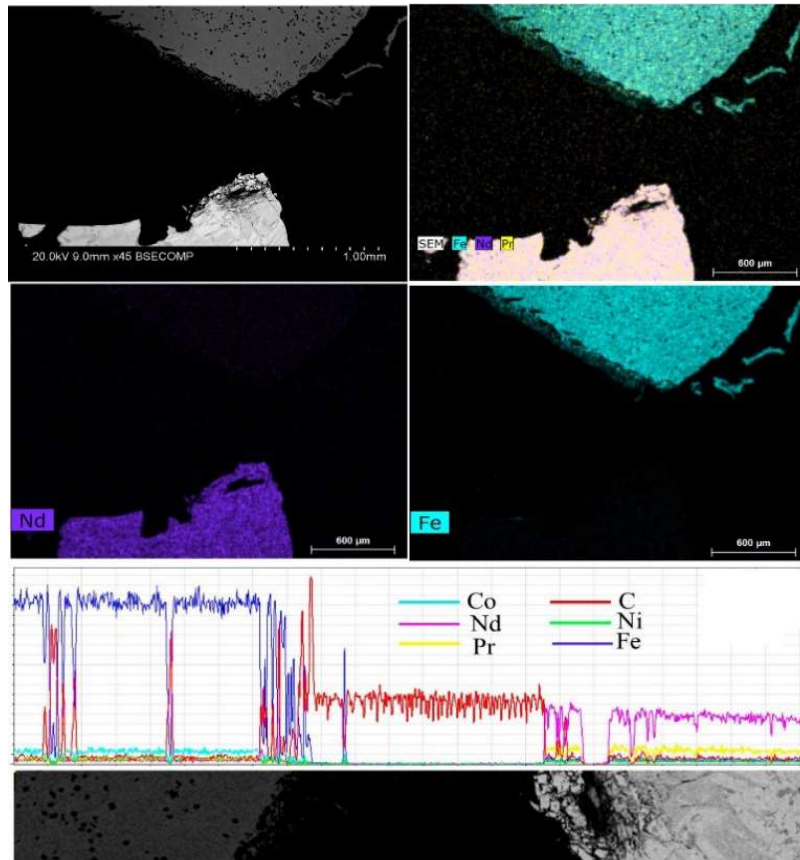
# Grenew® QPQ (Quench-Polish-Quench) Surface Modification Microfactory

New low cost technique for producing a corrosion and abrasion resistant surface on normal carbon steel, using waste as a resource.

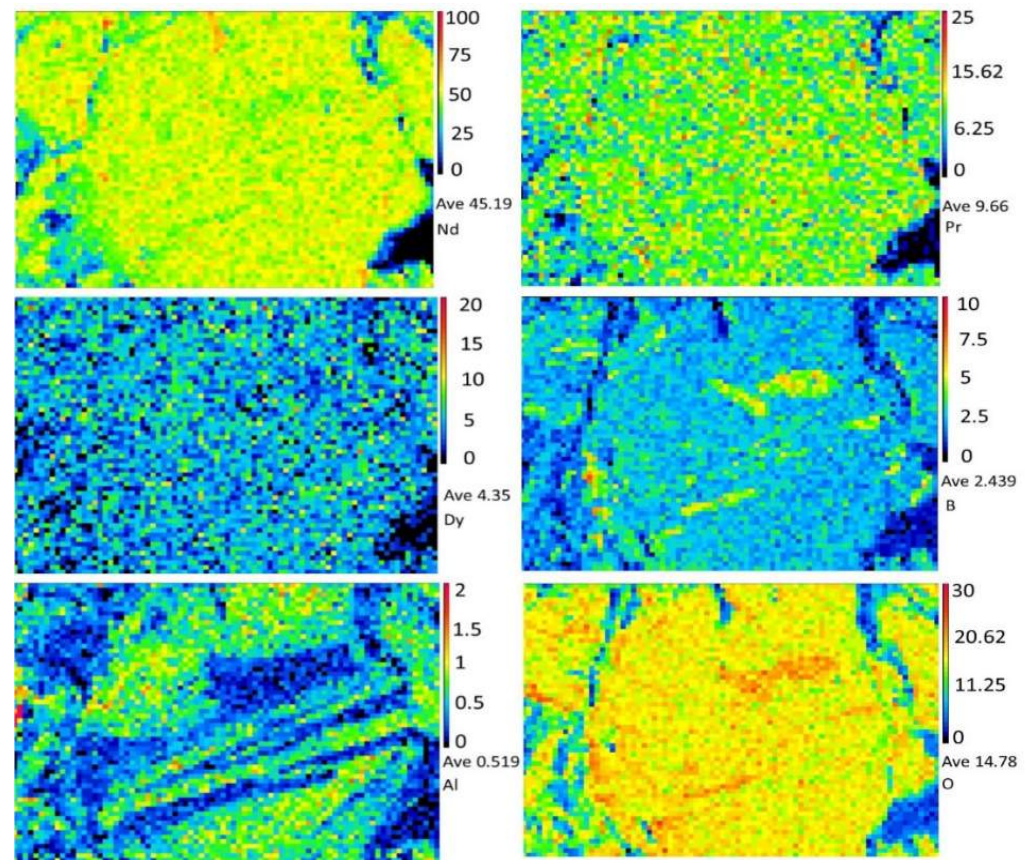


*By modifying the composition of the waste input and the processing parameters, the modified surface can be effectively customised to match the intended application of the steel.*

# Analysis of the Oxide Phase



BSE image and EDS element mappings and line scan of the Fe-based metal and oxides phases separated after heat treatment at 1450°C using WTR-DC for 90 minutes



EPMA elemental mapping of the REO phase



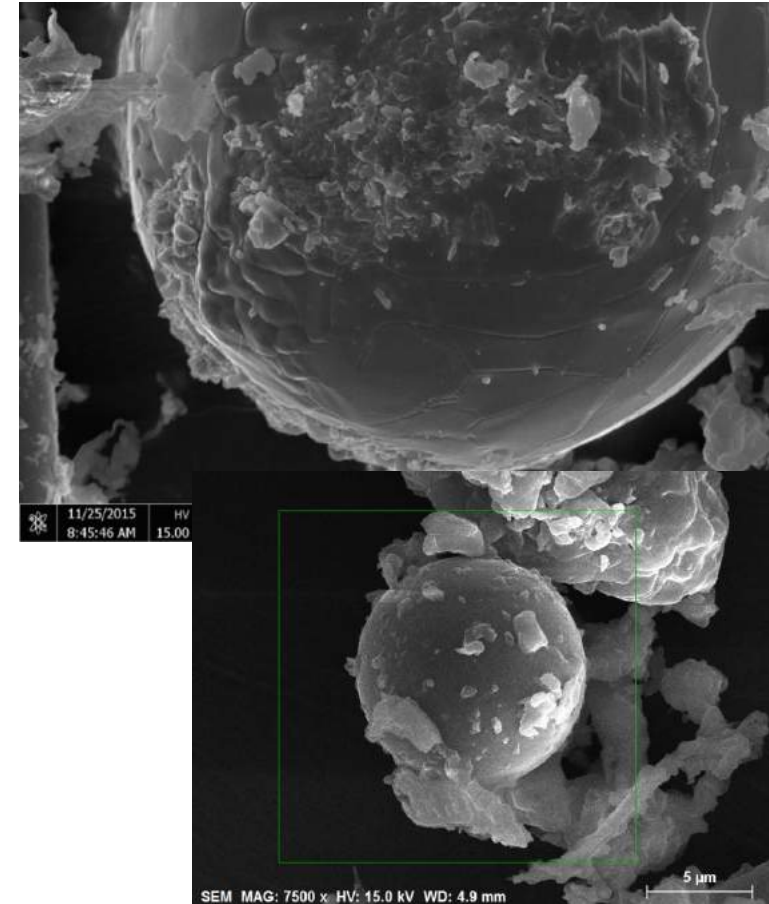
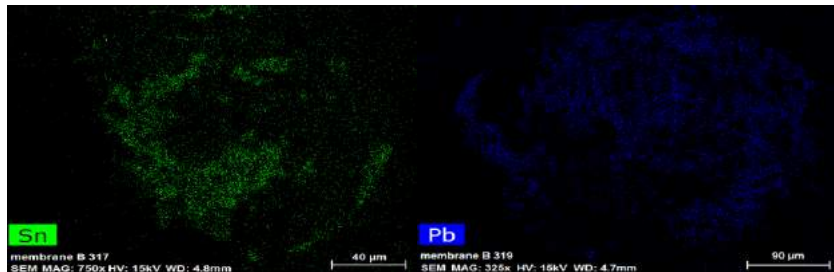
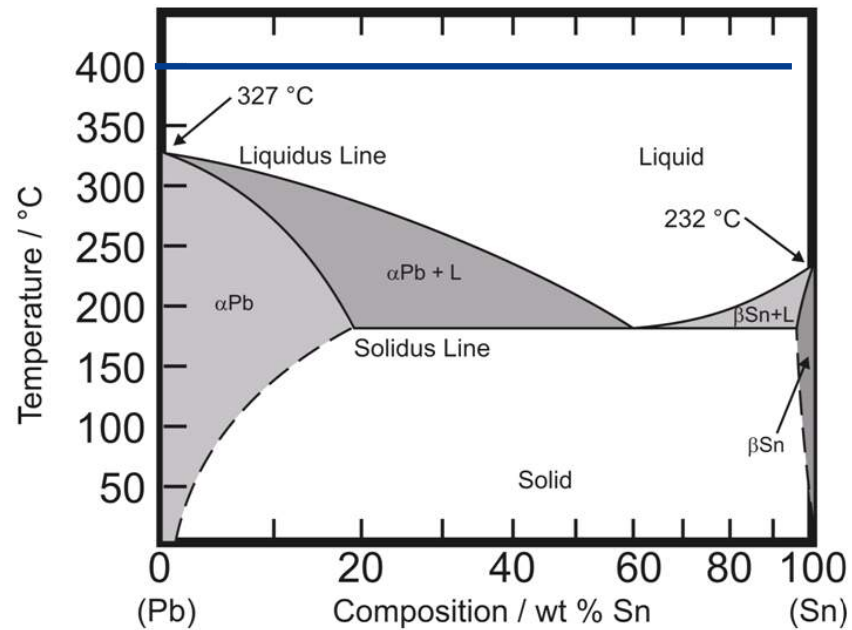
# Potential commercial metallic alloy

Alloy	Composition	Melting Point
<b>Wrought Copper alloys</b>		
<b>C10300 (Oxygen-free extra-low phosphorus copper)</b>	99.95Cu - 0.003P	1083
<b>C15735</b>	99.3 Cu - 0.7 Al2O3	1080
<b>C18900</b>	98.75 Cu - 0.75 Sn - 0.3 Si - 0.2 Mn	1075
<b>C19000 (Copper-Nickel-Phosphorus alloy)</b>	98.7 Cu - 1.1 Ni - 0.25 P	1085
<b>C22000 - Commercial Bronze</b>	90.0 Cu - 10.0 Zn	1045
<b>C31400 - Leaded Commercial bronze</b>	89.0 Cu - 1.75 Pb - 9.25 Zn	1040
<b>C31600 - Leaded Commercial bronze, nickel-bearing</b>	89.0 Cu - 1.9 Pb - 1.0 Ni - 8.1 Zn	1040
<b>C40500</b>	95 Cu - 1 Sn - 4 Zn	1060
<b>C54400 - Free cutting phosphor Bronze</b>	88.0 Cu - 4.0 Pb - 4.0 Zn - 4.0 Sn	1000
<b>Cast Copper alloy</b>		
<b>C83300 - Leaded red brasses</b>	93 Cu - 1.5 Sn - 1.5 Pb - 4 Zn	1060
<b>C90700 - Tin Bronze</b>	89 Cu - 11 Sn	1000
<b>C92500 - Leaded Tin Bronze</b>	87 Cu - 11 Sn - 1 Pb - 1 Ni	980
<b>C92700</b>	88 Cu - 10 Sn - 2 Pb	980
<b>C96200 - Copper Nickels</b>	88.6 Cu - 10 Ni - 1.4 Fe	1150
<b>Tin based alloys</b>		
<b>Tin based bearing alloy</b>	(Sn-Sb-Cu) small addition of Pb and Fe as impurities	400 (371)
<b>Tin-Zinc alloy</b>	91 Sn - 9.0 Zn	199
<b>Tin-Lead alloy</b>	61.86 Sn - 38.14 Pb	183





# PCB 4 – 400°C – (Powder)



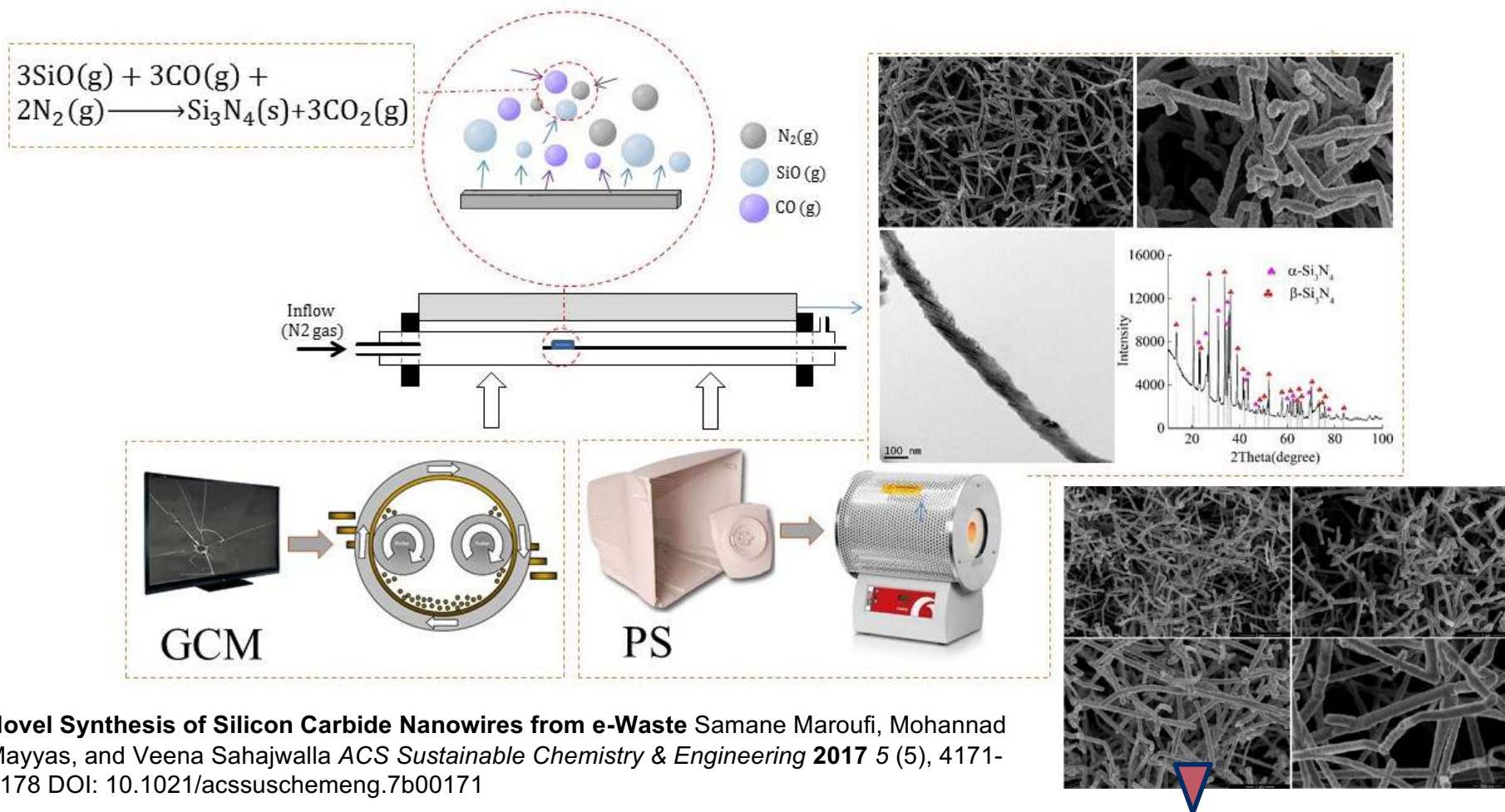
Ali Shokri, Farshid Pahlevani, Katie Levick, Ivan Cole, Veena Sahajwalla, Synthesis of copper-tin nanoparticles from old computer printed circuit boards, In Journal of Cleaner Production, Volume 142, Part 4, 2017, Pages 2586-2592, ISSN 0959-6526





# Synthesis of Si<sub>3</sub>N<sub>4</sub> Nanowires

Synthesis of Si<sub>3</sub>N<sub>4</sub> nanowires by using the same precursors at different process method



**Novel Synthesis of Silicon Carbide Nanowires from e-Waste** Samane Maroufi, Mohannad Mayyas, and Veena Sahajwalla *ACS Sustainable Chemistry & Engineering* **2017** 5 (5), 4171-4178 DOI: 10.1021/acssuschemeng.7b00171

# E-waste Sample Composition



Sample-ID	PCB 1	PCB 2	PCB 3	PCB 4	PCB 5
Al (wt%)	2.75	2.59	0.01	1.74	2.23
Bi (wt%)	0.03	0.01	0.06	0.10	0.02
Ca (wt%)	6.22	5.53	0.02	2.16	4.99
Cr (wt%)	0.01	0.02	0.00	0.01	0.01
Cu (wt%)	19.13	25.08	14.32	5.96	24.79
Fe (wt%)	0.19	0.29	0.54	0.08	0.40
Ge (wt%)	0.02	0.01	0.04	0.03	0.01
Mg (wt%)	0.10	0.07	0.02	0.07	0.09
Mn (wt%)	0.00	0.00	0.00	0.00	0.00
Ni (wt%)	0.07	0.38	0.09	0.06	0.31
P (wt%)	0.01	0.01	0.21	0.00	0.00
Pb (wt%)	0.03	0.03	0.19	3.26	0.44
Pd (wt%)	0.01	0.02	0.01	0.01	0.03
Sb (wt%)	0.01	0.01	0.02	1.22	0.01
Sn (wt%)	3.98	1.59	7.81	7.49	3.60
Zn (wt%)	0.02	0.02	0.00	0.01	0.02

# Composition of E-waste

- Electronic waste is a complex mixture, which contains different range of materials
  - Incompatible Polymers
    - 8 – 12 Basic polymers and flame retardant polymers
  - Metal and Oxides
    - More than 30 types of metal and 20 types of oxides

Material content of mobile phone

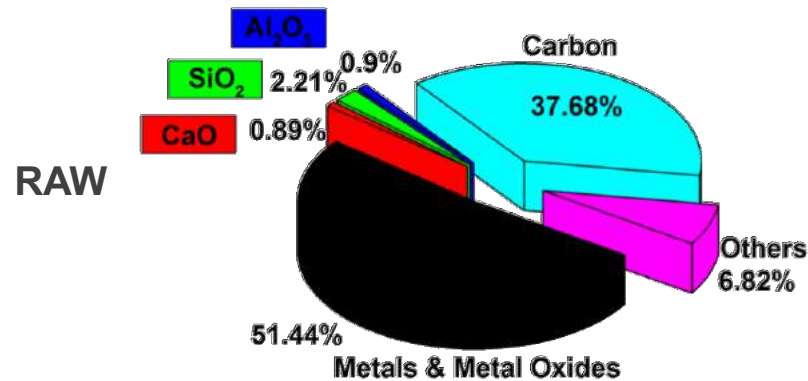
■ mobile phone substance (source Nokia)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
1 H 1.00794	2 He 4.0026																
3 Li 6.941	4 Be 9.0122											5 B 10.811	6 C 12.011	7 N 14.007	8 O 15.999	9 F 18.998	10 Ne 20.180
11 Na 22.990	12 Mg 24.305											13 Al 26.982	14 Si 28.086	15 P 30.974	16 S 32.065	17 Cl 35.453	18 Ar 39.948
19 K 39.098	20 Ca 40.078	21 Sc 44.956	22 Ti 47.867	23 V 50.942	24 Cr 51.996	25 Mn 54.938	26 Fe 55.845	27 Co 58.933	28 Ni 58.693	29 Cu 63.546	30 Zn 65.38	31 Ga 69.723	32 Ge 72.64	33 As 74.922	34 Se 78.96	35 Br 79.904	36 Kr 83.80
37 Rb 85.468	38 Sr 87.62	39 Y 88.906	40 Zr 91.224	41 Nb 92.906	42 Mo 95.94	43 Tc (98)	44 Ru 101.07	45 Rh 102.91	46 Pd 106.42	47 Ag 107.87	48 Cd 112.41	49 In 114.82	50 Sn 118.71	51 Sb 121.76	52 Te 127.60	53 I 126.90	54 Xe 131.29
55 Cs 132.91	56 Ba 137.33	57-71 La-Lu Lanthanides	72 Hf 178.49	73 Ta 180.95	74 W 183.84	75 Re 186.21	76 Os 190.23	77 Ir 192.22	78 Pt 195.08	79 Au 196.97	80 Hg 200.59	81 Tl 204.38	82 Pb 207.2	83 Bi 208.98	84 Po (209)	85 At (210)	86 Rn (222)
87 Fr (223)	88 Ra (226)	89-103 Ac-Lr Actinides	104 Rf (261)	105 Db (262)	106 Sg (266)	107 Bh (264)	108 Hs (277)	109 Mt (268)	110 Uun (281)	111 Uuu (272)	112 Uub (285)		114 Uuq (289)				

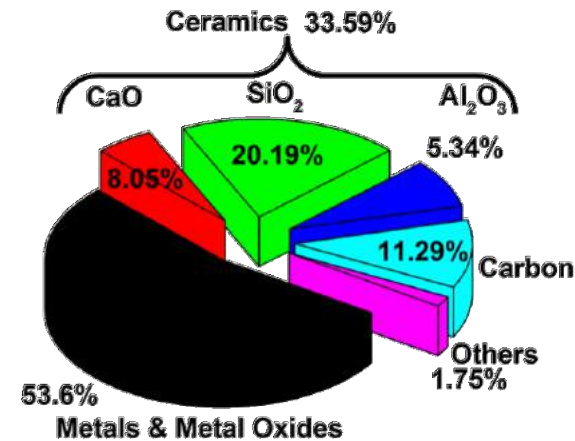
# XRF (X-Ray Fluorescence)

Single-sided WPCB (Monitor PCB)

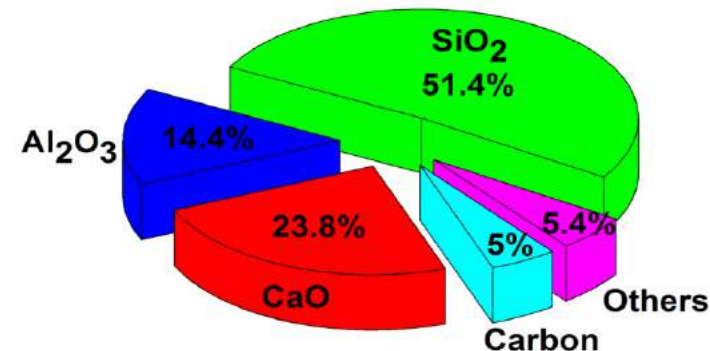
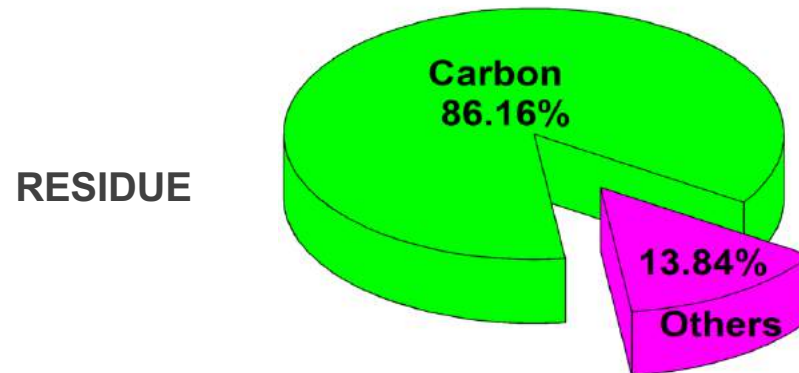
Multi-layered WPCB



(a)



(b)



*XRF Instrument: PANalytical PW2400 Sequential Wavelength Dispersive X-Ray Fluorescence spectrometry (WDXRF)*

Raman Rajagopal, Raghu & L S, Aravinda & Rajarao, Ravindra & Bhat, Badekai & Sahajwalla, Veena. (2016). Activated carbon derived from non-metallic printed circuit board waste for supercapacitor application. *Electrochimica Acta*. 211. 488-498. 10.1016/j.electacta.2016.06.077.



# PCB Elemental Analysis

Elemental analysis of PCBs at different temperatures by ICP. Results are the mean of three independent experiments.

Sample ID	PCB (wt%)	PCB-400 (wt%)	PCB-700 (wt%)	PCB-900 (wt%)
Ni	0.06	0.12	0.08	0.11
Fe	2.8	0.13	0.16	0.19
Zn	0.03	0.02	0.04	0.0
Cu	5.34	9.81	12.66	11.72
Sn	6.89	9.02	9.38	11.09
Al	1.91	2.66	2.63	2.61
Mg	0.06	0.09	0.1	0.11
Ca	1.97	3.4	3.67	4.18
K	0.01	0.02	0.02	0.02
Na	0.05	0.07	0.07	0.07
Bi	0.02	0.04	0.07	0.04
Sb	1.23	2.36	2.57	2.42
Pb	2.96	4.16	5.01	5.21

# Transforming e-waste plastic into filaments for additive manufacturing

